



General Description

The MAX2209 is a wideband (800MHz to 2GHz) RF power detector. It takes an RF signal from the directional coupler at the input, and outputs a DC voltage proportional to the RF peak voltage. The change in output voltage versus temperature is very repeatable from part to part and enables a lookup table based on nominal behavior, minimizing the effective detection error to less than ±0.5dB relative to room temperature.

The MAX2209 comes in a space-saving 2 x 2, 0.5mm pitch wafer-level package (WLP) and requires only two external components.

Applications

Dual-Band WCDMA Handsets High-Speed Downlink Packet Access (HSDPA) High-Speed Uplink Packet Access (HSUPA)

Features

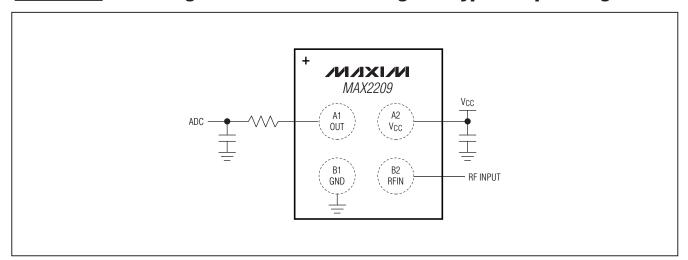
- → -25dBm to 0dBm Power Detection Range
- ♦ ±0.5dB Detection Error Due to Temperature
- ♦ +2.7V to +5V Single-Supply Operation
- ◆ Space-Saving 4-Bump, 1mm² UCSP™ Package
- ♦ On-Chip 50Ω Termination and DC-Blocking Capacitor

Ordering Information

PART	TEMP RANGE	PIN- PACKAGE	TOP MARK
MAX2209EBS+	-40°C to +85°C	4 UCSP	AGJ

+Denotes a lead(Pb)-free/RoHS-compliant package.

Pin Configuration/Functional Diagram/Typical Operating Circuit



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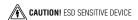
ABSOLUTE MAXIMUM RATINGS

V _{CC} to GND0.3V to +6V
RFIN to GND0.3V to + (V _{CC} + 0.3V)
OUT to GND0.3V to + (V _{CC} + 0.3V)
RFIN Input Power+10dBm
Continuous Power Dissipation ($T_A = +70^{\circ}C$)
4-Bump WLP (derate 3mW/°C above +70°C)238mW

Junction-to-Ambient Thermal	
Resistance (θJA) (Note 1)	335°C/W
Operating Temperature Range	40°C to +85°C
Storage Temperature Range	65°C to +160°C
Junction Temperature	+150°C
Bump Temperature (soldering, Note 2)	
Infrared (15s)	+260°C

- **Note 1:** Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a 4-layer board. For detailed information on package thermal considerations, refer to www.maxim-ic.com/thermal-tutorial.
- Note 2: For detailed information on soldering, refer to Application Note 1891: Wafer-Level Packaging (WLP) and Its Applications.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



DC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = 2.7V \text{ to } 5.0V, T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ no RF signal applied. Typical values are at } V_{CC} = 2.8V, T_A = +25^{\circ}\text{C}, \text{ unless otherwise noted.})$ (Note 3)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage		2.7		5.0	V
Supply Current			3.6	6	mA
Idle Output Voltage	V _{CC} = 2.8V, no RF signal		35		mV
Output Current Source Capability	PIN = 0dBm, Vout forced to 0.5V	750	1800		μΑ
Output Current Sink Capability	No RF signal, Vout forced to 2V	300	525		μΑ

AC ELECTRICAL CHARACTERISTICS

 $(T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}, 50\Omega \text{ system, V}_{CC} = 2.8\text{V}. \text{ Typical values are at } T_A = +25^{\circ}\text{C}, \text{ unless otherwise noted.})$ (Note 3)

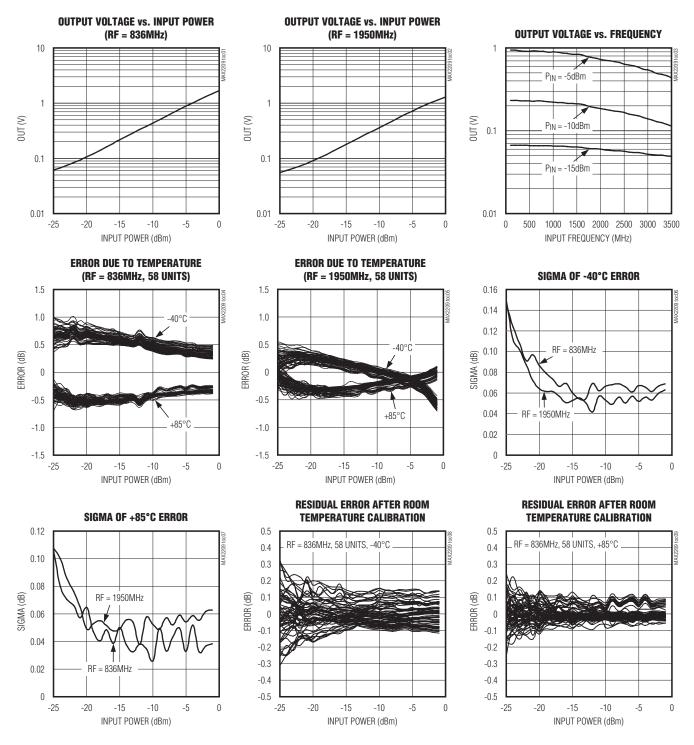
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
RF Input Frequency		800		2000	MHz	
RF Input VSWR	800MHz		-17		dB	
nr iliput vawn	2000MHz		-12		uB	
Output Voltage 926MHz	-5dBm input		0.88		V	
Output Voltage, 836MHz	-25dBm input		0.06		\ \ \ \ \ \	
Output Voltage 1050MHz	-5dBm input		0.72		V	
Output Voltage, 1950MHz	-25dBm input		0.06]	
Residual Error after Room Temperature Calibration	-5dBm input			±0.5	dB	
$(T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}) \text{ (Note 4)}$	-25dBm input			±1.5	ub	

Note 3: Guaranteed by production test at $T_A = +25$ °C. Guaranteed by design and characterization at $T_A = +85$ °C and $T_A = +85$ °C

Note 4: Guaranteed by design and characterization. See the Typical Operating Characteristics.

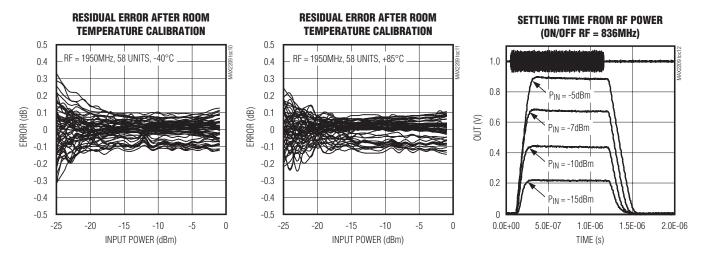
Typical Operating Characteristics

($V_{CC} = 2.8V$, typical values are at $T_A = +25$ °C, unless otherwise noted.)



Typical Operating Characteristics (continued)

 $(V_{CC} = 2.8V, typical values are at T_A = +25^{\circ}C, unless otherwise noted.)$



Pin Description

BUMP	NAME	FUNCTION	
A1	OUT	Detector Output	
A2	Vcc	Power Supply. Bypass to GND with a capacitor as close as possible to the bump.	
B1	GND	Ground Connection. Connect to PCB ground plane with as low inductance as possible.	
B2	RFIN RF Input. Internally terminated to 50Ω . AC-couple the RF input to this pin.		

Detailed Description

The MAX2209 power detector is designed to operate from 800MHz to 2.0GHz. The device is ideal for wideband code-division multiple access (WCDMA), cdma2000®, and high-speed downlink/uplink packet access. The MAX2209 accepts an RF signal at the input, and outputs a temperature-independent voltage related to the input signal voltage. The output voltage expressed in dBV is proportional to the input power expressed in dBm. The device has a detection range from -25dBm to 0dBm.

Applications Information

The MAX2209 contains an internal termination resistor for use with directional couplers. The typical application circuit is shown in Figure 1. The output of the detector goes to an ADC for further processing by the baseband system. Connect a series resistor and shunt capacitor to the MAX2209 output to reduce residual amplitude ripple.

Layout

There are two areas that require attention: the GND pin and the supply bypassing. Connect the GND pin to the PCB ground with a GND via as close as possible, and bypass VCC to ground with a capacitor as close as possible to the part.

_Chip Information

PROCESS: BIPOLAR

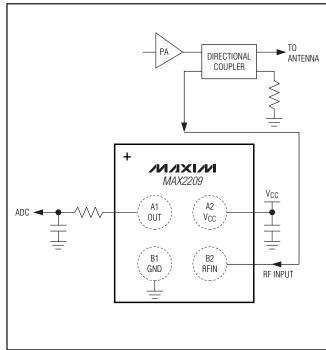


Figure 1. Typical Application Circuit

Package Information

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
4 UCSP	B4+4	21-0117

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